

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Priority Application Serial No. .... 09/518,511  
Priority Filing Date .... March 3, 2000  
Inventor .... Dinesh Chopra, et al  
Assignee .... Micron Technology, Inc.  
Priority Group Art Unit .... 2825  
Priority Examiner .... L. Malsawma  
Attorney's Docket No. .... MI22-1747  
Title: Conductive Connection Forming Methods, Oxidation Reducing Methods, and  
Integrated Circuits Formed Thereby

**PRELIMINARY AMENDMENT**

To: Box Patent Application  
Assistant Commissioner for Patents  
Washington, D.C. 20231

From: James E. Lake (Tel. 509-624-4276; Fax 509-838-3424)  
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**AMENDMENTS**

**In the Specification**

At p. 1, before the "Technical Field" section, insert

**--RELATED PATENT DATA**

This patent resulted from a divisional application of U.S. Patent  
Application Serial No. 09/518,511, filed on March 3, 2000.--

**In the Claims**

Cancel claims 1-46 without prejudice.

EL 844046847


**REMARKS**

Claims 1-46 are cancelled. Claims 47-54 are pending in the application.

Examination of claims 47-54 is requested.

Respectfully submitted,

Dated: 13 Jun 2001

By:   
James E. Lake  
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